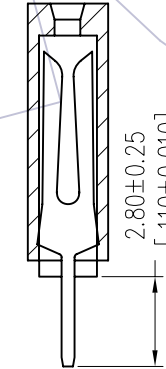
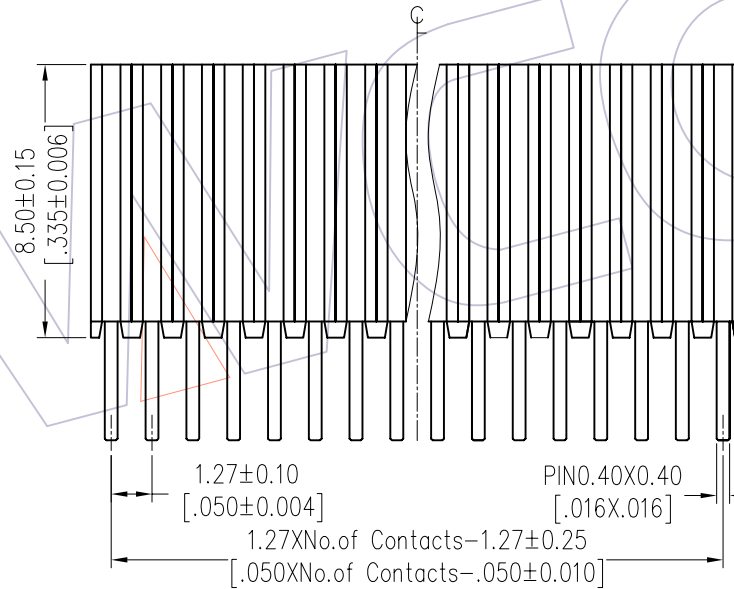
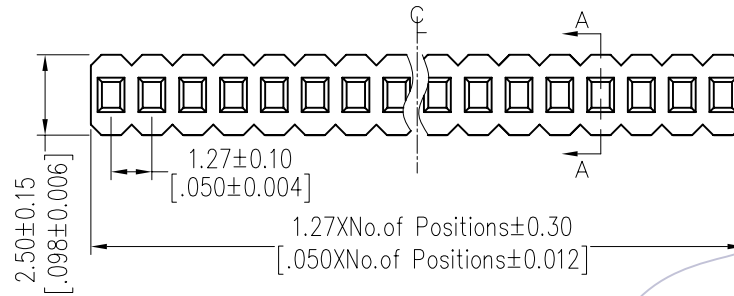
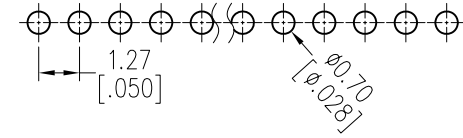


# HSF

NOTES:  
 Current Rating: 1.0AMP  
 Contact Resistance: 20mΩ Max  
 Withstand Voltage: 500V AC/DC  
 Insulation Resistance: 1000MΩ Min  
 Operation Temperature: -40°C to +105°C

Contact Material: Phosphor Bronze  
 Contact plating: Au over Ni  
 Insulator Material: PA9T+30%GF UL94V-0

Recommended P.C.B Layout (Top Side)  
 (PCB BOARD TOLERANCE ±0.05)



## Ordering Information

2385-1 XX S XX CYN T 1

No. of Pins per Row: 02-50 Pin

Contact Plating:  
 G0=Gold Flash  
 G3=10μ"Gold  
 G4=15μ"Gold  
 G5=30μ"Gold

Packing:  
 T=Tube

Item	Pitch	Mating
Standard	1.27	1317/1325
Alternate		

REV	DATE	MODIFICATION DESCRIPTION	CHANGE	OPERATION	DRAW	DATE	SCALE	FIT	PART NO.
				x.x ±0.40	JYHuang	2012/07/12	UNIT	mm	2385-1XXSXXCYNT1
				x.xx ±0.25	CHECK	DATE	SIZE	A4	TITLE:
				x.xxx ±0.15	APPROVE	DATE	SHEET	1/1	FH1.27mm SINGLE ROW 180° DIP
				Angle ± 3°			PROJ.	Customer NO.	H=8.50
				DIM TOL					